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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/682,028	10/10/2003	Bunshi Kuratomi	501.43128X00	8807	
20457	7590 06/20/2005		EXAM	EXAMINER	
ANTONELLI, TERRY, STOUT & KRAUS, LLP 1300 NORTH SEVENTEENTH STREET SUITE 1800			WILSON, CH	WILSON, CHRISTIAN D	
			ART UNIT	PAPER NUMBER	
ARLINGTON	, VA 22209-3873		2891		

DATE MAILED: 06/20/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

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		Application No.	Applicant(s)	V-1		
•		10/682,028	KURATOMI ET AL.			
	Office Action Summary	Examiner	Art Unit			
		Christian Wilson	2891			
Period fo	The MAILING DATE of this communication a or Reply	appears on the cover sheet with the	correspondence address			
A SH THE - Exte after - If the - If NC - Faild Any	IORTENED STATUTORY PERIOD FOR REF MAILING DATE OF THIS COMMUNICATION insions of time may be available under the provisions of 37 CFR SIX (6) MONTHS from the mailing date of this communication. e period for reply specified above is less than thirty (30) days, a reperiod for reply specified above, the maximum statutory perior to reply within the set or extended period for reply will, by start reply received by the Office later than three months after the mailed patent term adjustment. See 37 CFR 1.704(b).	N. 1.136(a). In no event, however, may a reply be tile reply within the statutory minimum of thirty (30) day od will apply and will expire SIX (6) MONTHS from tute, cause the application to become ABANDONE	mely filed ys will be considered timely. In the mailing date of this communication (COM) The mailing date of this communication (COM) The mailing date of this communication (COM) The mailing date of this communication The mailing date of this communica	on.		
Status						
1)	Responsive to communication(s) filed on	·		`		
2a) <u></u> ☐	This action is FINAL . 2b)⊠ T	his action is non-final.				
3)	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.					
Disposit	ion of Claims					
5)□ 6)⊠ 7)⊠	Claim(s) <u>1-17</u> is/are pending in the application 4a) Of the above claim(s) is/are with definition claim(s) is/are allowed. Claim(s) <u>1-5 and 11-17</u> is/are rejected. Claim(s) <u>6-10</u> is/are objected to. Claim(s) are subject to restriction and	Irawn from consideration.				
Applicat	ion Papers					
10)⊠	The specification is objected to by the Examination The drawing(s) filed on <u>10 October 2003</u> is/a Applicant may not request that any objection to the Replacement drawing sheet(s) including the correct The oath or declaration is objected to by the	are: a)⊠ accepted or b)⊡ objected he drawing(s) be held in abeyance. Se rection is required if the drawing(s) is ob	e 37 CFR 1.85(a). ojected to. See 37 CFR 1.121('d).		
Priority	under 35 U.S.C. § 119					
a)	Acknowledgment is made of a claim for forei All b) Some * c) None of: 1. Certified copies of the priority docume 2. Certified copies of the priority docume 3. Copies of the certified copies of the priority docume application from the International Burd See the attached detailed Office action for a least	ents have been received. ents have been received in Applicat riority documents have been receiv eau (PCT Rule 17.2(a)).	ion No ed in this National Stage			
2) Notice 3) Infor	ce of References Cited (PTO-892) ce of Draftsperson's Patent Drawing Review (PTO-948) mation Disclosure Statement(s) (PTO-1449 or PTO/SB/0 er No(s)/Mail Date 10102003.	4) Interview Summary Paper No(s)/Mail D 5) Notice of Informal I 6) Other: search history	ate Patent Application (PTO-152)			

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DETAILED ACTION

Claim Rejections - 35 USC § 112

- 1. The following is a quotation of the second paragraph of 35 U.S.C. 112:
 - The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter which the applicant regards as his invention.
- 2. Claims 12 16 are rejected under 35 U.S.C. 112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention.
- 3. Claims 12 16 recite the limitation "the movable pins". There is insufficient antecedent basis for this limitation in the claim. For purposes of examination, it will be assumed that claims 12 16 should depend from claim 6, which is the first stated instance of movable pins.

Claim Rejections - 35 USC § 102

4. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.
- 5. Claims 1, 2, 4, 5 and 11 are rejected under 35 U.S.C. 102(e) as being anticipated by Shimizu *et al*.

Shimizu et al. (US 6,676,885) discloses a method of manufacturing a semiconductor device comprising the steps of forming a board 11, mounting semiconductor chips 12 over the board, arranging the board over a mold surface of a mold 22 for resin molding and closing a

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mold [Figure 4A], and setting depths of air vents 45a communicating with cavities of the mold to a fixed value [column 12, lines 60-65] and filling sealing resin 26 in the inside of the cavities.

Regarding claim 2, Shimizu *et al.* further discloses a multilayered printed wiring circuit board [column 10, lines 1-10].

Regarding claim 4, Shimizu et al. further discloses a core member 51 formed of resin.

Regarding claim 11, Shimizu et al. further discloses a plurality of air vents [Figure 3B].

Regarding claim 5, Shimizu *et al.* discloses preparing a multilayered printed wiring circuit board 11 with a plurality of device forming regions and chip mounting portions in a matrix, mounting semiconductor chips 12 on the chip mounting portions, arranging the board on a mold surface of a mold 22 and closing the mold [Figure 4A] with a cavity 23a of the mold, setting depths of air vents 45a communicating with the cavity of the mold to a fixed value [column 12, lines 60-65] and filling sealing resin 26 in the cavity, and dividing the board into pieces corresponding to the device forming regions [Figure 6].

Claim Rejections - 35 USC § 103

- 6. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 7. Claims 3 and 17 are rejected under 35 U.S.C. 103(a) as being unpatentable over Shimizu et al. in view of Saxelby et al.

Shimizu *et al.* discloses preparing a multilayered printed wiring circuit board **11** with a plurality of device forming regions and chip mounting portions in a matrix, mounting

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semiconductor chips 12 on the chip mounting portions, arranging the board on a mold surface of a mold 22 and closing the mold [Figure 4A] with a cavity 23a of the mold, setting depths of air vents 45a communicating with the cavity of the mold to a fixed value [column 12, lines 60-65] and filling sealing resin 26 in the cavity, and dividing the board into pieces corresponding to the device forming regions [Figure 6]. Shimizu *et al.* does not discuss a plurality of wiring boards. Saxelby *et al.* (US 5,728,600) teaches a molding process where a plurality of boards are mounted in the mold [Figure 19]. It would have been obvious to one of ordinary skill in the art to use the mulitple board mounting process of Saxelby *et al.* in the method of Shimizu *et al.* since Saxelby *et al.* teaches that multiple board mounting provides a method of simultaneous resin encapsulation.

Allowable Subject Matter

- 8. Claims 6 10 are objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.
- 9. Claims 12 16 would be allowable if rewritten to overcome the rejection(s) under 35 U.S.C. 112, 2nd paragraph, set forth in this Office action and to include all of the limitations of the base claim and any intervening claims.
- 10. The following is a statement of reasons for the indication of allowable subject matter: the applicant claims in claim 6 movable pins which are formed to project into the air vents formed in the mold.

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Conclusion

- 11. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. The cited prior art teaches methods of encapsulating a semiconductor package with air vents formed around the die cavity.
- 12. A copy of the EAST search history is enclosed.
- 13. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Christian Wilson whose telephone number is (571) 272-1886. The examiner can normally be reached on weekdays, 7:30 AM to 4 PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Bill Baumeister can be reached on (571) 272-1722. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Christian Wilson, Ph.D.

Primary Examiner

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